COPY



DISCO CORPORATION

This is a multi-site certificate, additional site(s) are listed on the next page(s)

4010-1, Gohara-cho, Kure-shi, Hiroshima, 737-0161, Japan

Bureau Veritas Certification Holding SAS -UK Branch certifies that the Management System of the above organisation has been audited and found to be in accordance with the requirements of the management system standards detailed below

ISO14001:2015, JIS Q 14001:2015

Scope of certification

- Design / development, manufacturing, installation / maintenance services and supply of service parts of precision processing machines and systems for cutting, grinding and polishing of silicon wafers and other materials.
- Design / development and manufacturing of precision processing tools for cutting, grinding and polishing of silicon wafers and other materials.
- Manufacturing of functional consumables (assisting materials) for cutting, grinding and polishing of silicon wafers and other materials.
- · Design / development and manufacturing of abrasive cut-off wheels.
- · Supply of precision processing services.

Original cycle start date: 27 FEBRUARY 1998

Expiry date of previous cycle: N/A

Recertification Audit date: 15 JULY 2022

Recertification cycle start date: 26 JULY 2022

Subject to the continued satisfactory operation of the organisation's Management System,

this certificate expires on: 09 AUGUST 2025

Certificate No. 4724306 Version: 3.0 Revision date: 05 AUGUST 2024





8000

Certification body address: 5th Floor, 66 Prescot Street, London, E1 8HG, United Kingdom

Local office: Bureau Veritas Japan Co., Ltd. Certification Division

KRC bldg. 8F, 18, Nihon-odori, Naka-ku, Yokohama, 231-0021, Japan

Further clarifications regarding the scope of this certificate and the applicability of the management system requirements may be obtained by consulting the organisation.

To check this certificate validity please call: +81 (0)45-651-4784







DISCO CORPORATION

ISO14001:2015, JIS Q 14001:2015

Scope of certification

- Design / development, manufacturing, installation / maintenance services and supply of service parts of precision processing machines and systems for cutting, grinding and polishing of silicon wafers and other materials.
- Design / development and manufacturing of precision processing tools for cutting, grinding and polishing of silicon wafers and other materials.
- Manufacturing of functional consumables (assisting materials) for cutting, grinding and polishing of silicon wafers and other materials.
- · Design / development and manufacturing of abrasive cut-off wheels.
- · Supply of precision processing services.

Site Name	Site Address	Site Scope
Kuwabata Plant	4010-1, Gohara-cho, Kure-shì, Hiroshima, 737-0161, Japan	 Design / dvelopment and manufacturing of precision processing machines and systems for cutting, grinding and polishing of silicon wafer and other materials. Design / development and manufacturing of precision processing tools for cutting, grinding and polishing of silicon wafer and other materials. Manufacturing of functional consumables (assisting materials) for cutting, grinding and polishing of silicon wafer and other materials.
Kure Plant	1-23, Hiro Bunka-cho, Kure-shi, Hiroshima, 737-0198, Japan	 Manufacturing and sales of precision processing tools for cutting, grinding and polishing of silicon wafer and other materials. Design / development, manufacturing and sales of abrasive cut-off wheels.
Chino Plant	480, Toyohira, Chino-shi, Nagano, 391-0297, Japan	 Design / development and manufacturing of precision processing machines and systems for cutting, grinding and polishing of silicon wafer and other materials. Manufacturing of precision processing tools for cutting, grinding and polishing of silicon wafer and other materials.

Certificate No. 4724306

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DISCO CORPORATION

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Scope of certification

- Design / development, manufacturing, installation / maintenance services and supply of service parts of precision processing machines and systems for cutting, grinding and polishing of silicon wafers and other materials.
- Design / development and manufacturing of precision processing tools for cutting, grinding and polishing of silicon wafers and other materials.
- Manufacturing of functional consumables (assisting materials) for cutting, grinding and polishing of silicon wafers and other materials.
- · Design / development and manufacturing of abrasive cut-off wheels.
- · Supply of precision processing services.

Site Name	Site Address	Site Scope
DISCO HI-TEC EUROPE GmbH	Liebigstrasse 8, D-85551 Kirchheim b. Muenchen, Germany	Sales, installation / maintenance services and supply of service parts of precision processing machines and systems for cutting, grinding and polishing of silicon wafer and other materials. Sales of precision processing tools for cutting, grinding and polishing of silicon wafer and other materials. Sales of functional consumables (assisting materials) for cutting, grinding and polishing of silicon wafer and other materials. Supply of precision processing services.

Certificate No. 4724306

Version: 3.0

Revision date: 05 AUGUST 2024





0008

Certification body address: 5th Floor, 66 Prescot Street, London, E1 8HG, United Kingdom Local office: Bureau Veritas Japan Co., Ltd. Certification Division

KRC bldg. 8F, 18, Nihon-odori, Naka-ku, Yokohama, 231-0021, Japan

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